

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT3168267

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
YU LEI	01/02/2015
YIXIN LIU	01/02/2015
RECEIVING PARTY DATA	
Name:	UNIVERSITY OF CONNECTICUT
Street Address:	263 FARMINGTON AVENUE
City:	FARMINGTON
State/Country:	CONNECTICUT
Postal Code:	06030-6400
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14532521
CORRESPONDENCE DATA	
Fax Number:	(203)399-5822
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	203-399-5920
Email:	jsimmons@mccarter.com
Correspondent Name:	MCCARTER & ENGLISH, LLP STAMFORD
Address Line 1:	CANTERBURY GREEN
Address Line 2:	201 BROAD STREET
Address Line 4:	STAMFORD, CONNECTICUT 06901
ATTORNEY DOCKET NUMBER:	98121.00230
NAME OF SUBMITTER:	BASAM E. NABULSI
SIGNATURE:	/Basam E. Nabulsi/
DATE SIGNED:	01/02/2015
Total Attachments: 2	
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source=UConn .00230 Assignment#page2.tif	

ASSIGNMENT

For good and valuable consideration, the receipt of which is hereby acknowledged,
I the undersigned,

Yu Lei, 46 Adeline Place, Mansfield Center, CT 06250

Yixin Liu, 75 Hockanum Blvd, Unit 2426, Vernon, CT 06066

(insert full name(s) and post office addresses of inventors)

(hereinafter, "Assignor"), who has created a certain invention for which an
application for United States Letters Patent entitled:

**HIGH TEMPERATURE SENSOR SELECTIVE
FOR PROPANE AND OTHER REDUCING GASES**

(insert title of invention)

(check one)

- for which the application is attached hereto; or
- for which the application for U.S. Letters Patent has been filed on
November 4, 2014, as Application Serial No. 14/532,521.

Do hereby sell, assign and transfer to:

University of Connecticut, 263 Farmington Avenue, Farmington, CT 06030-6400

(insert full name(s) and post office addresses of assignee)

(hereinafter, "Assignee"), its successors, assigns, and legal representatives, the
full and exclusive right to said invention and said application and to any and all
inventions described in said application for the United States, its territorial
possessions and all foreign countries, and the entire right, title and interest in and
to any and all Letters Patent which may be granted therefor in the United States,
its territorial possessions and all foreign countries; and in and to any and all
continuations-in-part, continuations, divisions, substitutes, reissues, extensions
thereof, and all other applications for Letters Patent relating thereto which have
been or shall be filed in the United States, its territorial possessions and/or any
foreign countries, and all rights, together with all priority rights, under any of the
international conventions, unions, agreements, acts, and treaties, including all
future conventions, unions, agreements, acts, and treaties;

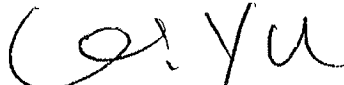
I authorize Assignee to apply for and receive Letters Patent for such protection in its own name, in the United States, its territorial possessions, and all foreign countries; and that, when requested to carry out in good faith the intent and purpose of this assignment, at the expense of said Assignee, but without charge to Assignee, its successors, assigns and legal representatives, the undersigned will execute all continuations-in-part, continuations, divisions, substitutes, reissues, and extensions thereof, execute all rightful oaths, assignments, powers of attorney and other papers, testify in any legal or quasi legal proceedings; communicate to said Assignee, its successors, assigns, and legal representatives all facts known to the undersigned relating to said invention and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing, maintaining and enforcing proper patent protection for said invention and for vesting title to said invention and all applications for patents on said invention in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

IN TESTIMONY WHEREOF, I have hereunto set my signature below.

Signature of inventor:


Date: 01/02/15



Yu Lei

Signature of inventor:

Date: 01/02/2015



Yixin Liu